

# STGB10NC60K

### 10 A, 600 V short-circuit rugged IGBT

### Features

- Low on voltage drop (V<sub>CESAT</sub>)
- Short-circuit withstand time 10 µs

### Applications

- High frequency motor controls
- SMPS and PFC in both hard switch and resonant topologies
- Motor drives

### Description

This device utilizes the advanced Power MESH™ process resulting in an excellent trade-off between switching performance and low on-state behavior.

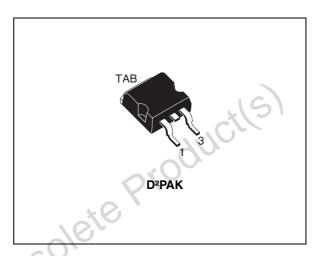
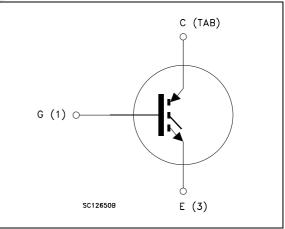


Figure 1. Internal schematic diagram



Part number	Marking	Package	Packaging
STGB10NC60KT4	GB10NC60K	D <sup>2</sup> PAK	Tape and reel

Doc ID 11842 Rev 4

# 1 Electrical ratings

Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GE</sub> = 0)	600	V
$I_{C}^{(1)}$	Continuous collector current at $T_C = 25^{\circ}C$	20	А
$I_{C}^{(1)}$	Continuous collector current at T <sub>C</sub> = 100°C	10	А
I <sub>CL</sub> <sup>(2)</sup>	Turn-off latching current	30	А
I <sub>CP</sub> <sup>(3)</sup>	Pulsed collector current	30	Α
$V_{GE}$	Gate-emitter voltage	±20	V
P <sub>TOT</sub>	Total dissipation at $T_{C} = 25^{\circ}C$	65	W
T <sub>STG</sub>	Storage temperature	- 55 to 150	°C
TJ	Operating junction temperature	- 55 10 150	U
t <sub>SCW</sub>	Short-circuit withstand time ( $V_{CE}$ = 0.5 $V_{CES}$ , T <sub>J</sub> = 125 °C, R <sub>G</sub> = 10 Ω, V <sub>GE</sub> = 12 V)	10	μs

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2.  $V_{clamp} = 80 \% V_{CES}$ ,  $V_{GE} = 15 V$ ,  $R_G = 10 \Omega$ ,  $T_J = 150 \degree C$
- 3. Pulse width limited by maximum junction temperature and turn-off within RBSOA

	Table	3.	Thermal	data
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	Symbol	Parameter	Value	Unit
10	R <sub>thJC</sub>	Thermal resistance junction-case	1.9	°C/W
	R <sub>thJA</sub>	Thermal resistance junction-ambient	62.5	°C/W
0050				



#### **Electrical characteristics** 2

T <sub>J</sub> = 25 °C unless otherwise specified
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Parameter ollector-emitter breakdown bltage (V <sub>GE</sub> = 0)	Test conditions	Min.	Тур.	Max.	Unit
(VGE- 0)	I <sub>C</sub> = 1mA	600			V
ollector-emitter saturation	V <sub>GE</sub> = 15V, I <sub>C</sub> = 5A V <sub>GE</sub> = 15V, I <sub>C</sub> = 5A, T <sub>J</sub> =125°C		2.2 1.8	2.5	V V
ate threshold voltage	$V_{CE}$ = $V_{GE}$ , $I_C$ = 250 $\mu$ A	4.5		6.5	v
ollector cut-off current / <sub>GE</sub> = 0)	V <sub>CE</sub> = 600 V V <sub>CE</sub> = 600 V, T <sub>J</sub> = 125 °C			150 1	μA mA
ate-emitter leakage urrent (V <sub>CE</sub> = 0)	V <sub>GE</sub> = ± 20 V	0	7	±100	nA
orward transconductance	$V_{CE} = 15 V_{,} I_{C} = 5A$		15		S
	tage the threshold voltage filector cut-off current GE = 0 the emitter leakage rrent (V <sub>CE</sub> = 0)	trage $V_{GE}$ = 15V, $I_C$ = 5A, $T_J$ = 125°Cte threshold voltage $V_{CE}$ = $V_{GE}$ , $I_C$ = 250 µAellector cut-off current $V_{CE}$ = 600 V $GE$ = 0) $V_{CE}$ = 600 V, $T_J$ = 125 °Centeremitter leakage $V_{GE}$ = ± 20 V	trage $V_{GE}$ = 15V, $I_C$ = 5A, $T_J$ = 125°Cte threshold voltage $V_{CE}$ = $V_{GE}$ , $I_C$ = 250 $\mu$ A4.5illector cut-off current $V_{CE}$ = 600 V $GE$ = 0) $V_{CE}$ = 600 V, $T_J$ = 125 °Citte-emitter leakage $V_{GE}$ = ± 20 V	Itage $V_{GE}$ $15V, I_C$ $5A, T_J$ $125^{\circ}C$ $1.8$ Ite threshold voltage $V_{CE}$ $V_{GE}$ $250, \mu$ $4.5$ Illector cut-off current $V_{CE}$ $600 V$ $V_{CE}$ $4.5$ Illector cut-off current $V_{CE}$ $600 V$ $V_{CE}$ $600 V$ Inte-emitter leakage $V_{CE}$ $200 V$ $V_{CE}$ $100 V$ Inte-emitter leakage $V_{GE}$ $20 V$ $V_{GE}$ $100 V$	IndexVGE15V, IC1011.8Itage $V_{GE}$ = 15V, IC5A, TJ=125°C1.8Ite threshold voltage $V_{CE}$ = $V_{GE}$ , IC250 $\mu$ A4.5Illector cut-off current $V_{CE}$ = 600 V150Illector cut-off current $V_{CE}$ = 600 V, TJ = 125 °C1Inte-emitter leakage $V_{GE}$ = ± 20 V±100

Table 4 Static

	Table	5.	Dynamic
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9 <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>CE</sub> = 15 V, I <sub>C</sub> = 5A		15		S
1. Pulse te	st: pulse duration < 300 μs, duty c	cycle < 2 %.				
Table 5.	Dynamic	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25V, f = 1MHz, V <sub>GE</sub> = 0		380 46 8.5		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390V, I_C = 5A,$ $V_{GE} = 15V,$ (see Figure 17)		19 5 9		nC nC nC

### Switching on/off (inductive load)

Table 6. Switching on/off (inductive load)SymbolParameterTest conditionsMin.Typ.Max.Un $t_{d(on)}$ Turn-on delay time $V_{CC} = 390V, I_C = 5A$ 17ns $t_r$ Current rise time $R_G = 10\Omega, V_{GE} = 15V,$ 6ns(di/dt)_{on}Turn-on current slope(see Figure 18)655A/µ $t_{d(on)}$ Turn-on delay time $V_{CC} = 390V, I_C = 5A$ 16.5ns $t_r$ Current rise time $R_G = 10\Omega, V_{GE} = 15V, Tj = 125^{\circ}C$ 6.5ns(di/dt)_{on}Turn-on current slope(see Figure 18)575A/µ $t_r$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 33ns $t_f(V_{off})$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 33ns $t_f(V_{off})$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 33ns $t_f(V_{off})$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 60ns $t_f(0_{off})$ Turn-off delay time $R_{GE} = 10\Omega, V_{GE} = 15V, Tj = 125^{\circ}C$ 106ns $t_f(0_{off})$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 60ns $t_f(0_{off})$ Off voltage rise time $V_{cc} = 390V, I_C = 5A,$ 60ns $t_f(0_{off})$ Turn-off delay time $R_{GE} = 10\Omega, V_{GE} = 15V, Tj = 125^{\circ}C$ 106ns		ge		GE (GE)		-		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		Q <sub>gc</sub>	Gate-collector charge	(see Figure 17)		9		nC
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		20						
$\begin{array}{c c c c c c c c c c c c c c c c c c c $		Table 6.	Switching on/off (ind	uctive load)				
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	absor	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	<b>O</b> P	t <sub>d(on)</sub>	Turn-on delay time	$V_{CC} = 390V, I_{C} = 5A$		17		ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		t <sub>r</sub>	Current rise time	R <sub>G</sub> = 10Ω, V <sub>GE</sub> = 15V,		6		ns
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		(di/dt) <sub>on</sub>	Turn-on current slope	(see Figure 18)		655		A/µs
		t <sub>d(on)</sub>	Turn-on delay time	V <sub>CC</sub> = 390V, I <sub>C</sub> = 5A		16.5		ns
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $		t <sub>r</sub>	Current rise time	R <sub>G</sub> = 10Ω, V <sub>GE</sub> = 15V, Tj=125°C		6.5		ns
$\begin{array}{c c} t_{d}(_{off}) & Turn-off delay time \\ t_{f} & Current fall time \\ t_{r}(V_{off}) & Off voltage rise time \\ t_{d}(_{off}) & Turn-off delay time \\ t_{r}(V_{off}) & Off voltage rise time \\ t_{d}(_{off}) & Turn-off delay time \\ t_{d}(_{off}) & Turn-off de$		(di/dt) <sub>on</sub>	Turn-on current slope	(see Figure 18)		575		A/µs
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		t <sub>r</sub> (V <sub>off</sub> )	Off voltage rise time	$V_{cc} = 390V, I_C = 5A,$		33		ns
$t_r(V_{off})$ Off voltage rise time $V_{cc} = 390V$ , $I_C = 5A$ ,60ns $t_d(_{off})$ Turn-off delay time $R_{GE}=10\Omega$ , $V_{GE}=15V$ , $Tj=125^{\circ}C$ 106ns		t <sub>d</sub> ( <sub>off</sub> )	Turn-off delay time	$R_{GE} = 10\Omega$ , $V_{GE} = 15V$ ,		72		ns
$t_{d(off)}$ Turn-off delay time $R_{GE}=10\Omega$ , $V_{GE}=15V$ , Tj=125°C 106 ns		t <sub>f</sub>	Current fall time	(see Figure 18)		82		ns
		t <sub>r</sub> (V <sub>off</sub> )	Off voltage rise time	$V_{cc} = 390V, I_{C} = 5A,$		60		ns
t <sub>f</sub> Current fall time <i>(see Figure 18)</i> 136 ns		t <sub>d</sub> ( <sub>off</sub> )	Turn-off delay time	R <sub>GE</sub> =10Ω, V <sub>GE</sub> =15V, Tj=125°C		106		ns
		t <sub>f</sub>	Current fall time	(see Figure 18)		136		ns



Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390V, I_C = 5A$ $R_G = 10\Omega, V_{GE} = 15V,$ <i>(see Figure 18)</i>		55 85 140		μJ μJ μJ
E <sub>on</sub> <sup>(1)</sup> E <sub>off</sub> <sup>(2)</sup> E <sub>ts</sub>	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390V, I_C = 5A$ $R_G = 10\Omega, V_{GE} = 15V,$ $Tj = 125^{\circ}C$ <i>(see Figure 18)</i>		87 162 249		μJ μJ μJ

Table 7. Switching energy (inductive load)

 Eon is the tun-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a
package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same
temperature (25°C and 125°C) oduci

2. Turn-off losses include also the tail of the collector current

#### **Electrical characteristics (curves)** 2.1

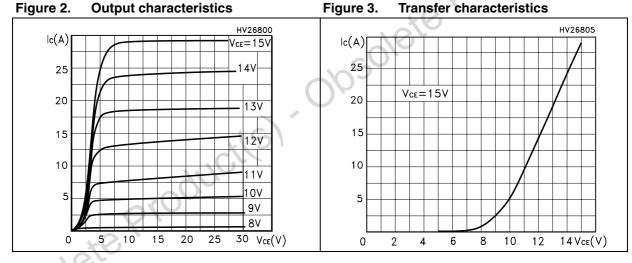
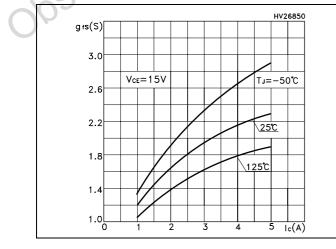
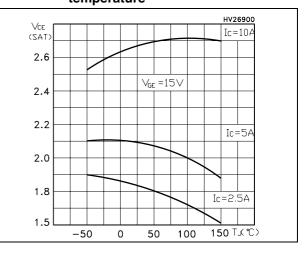




Figure 5.

Collector-emitter on voltage vs temperature







Vge

(V)

Figure 6. Gate charge vs. gate-source voltage

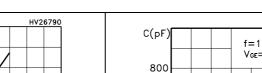


Figure 7.

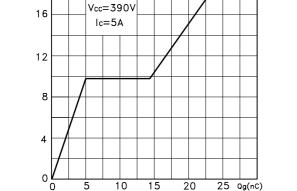


Figure 8. Normalized gate threshold voltage Figure 9. vs. temperature

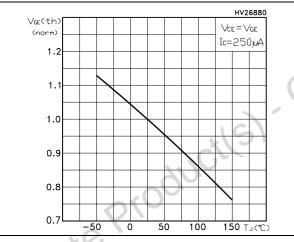
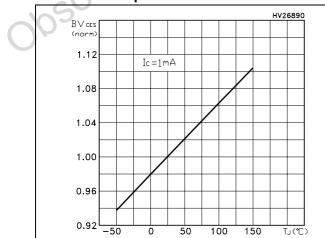
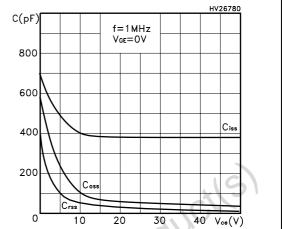


Figure 10. Normalized breakdown voltage vs temperature



**Capacitance variations** 



Collector-emitter on voltage vs collector current

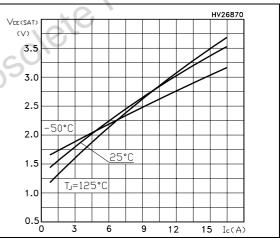
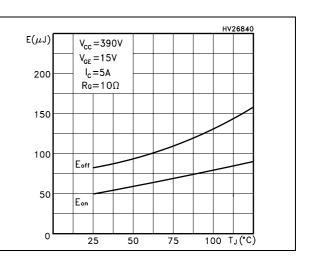


Figure 11. Switching losses vs temperature





Switching losses vs collector

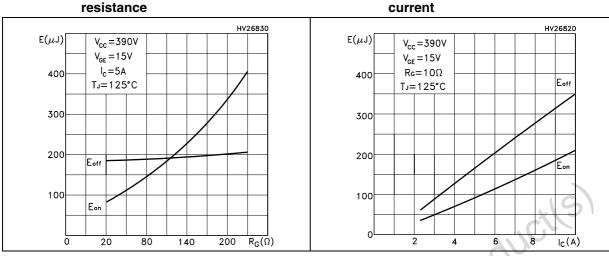


Figure 13.

# Figure 12. Switching losses vs. gate resistance

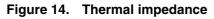


Figure 15. Turn-off SOA

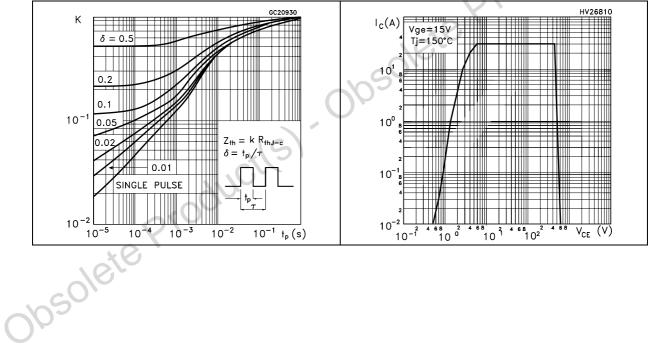


Figure 17. Gate charge test circuit

## 3 Test circuits

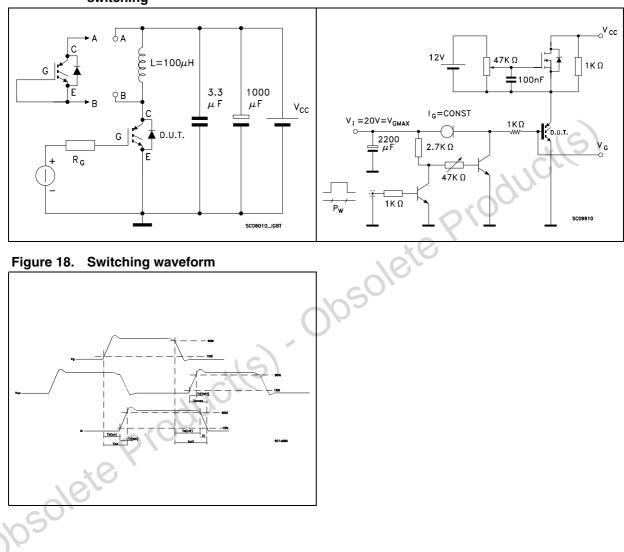


Figure 16. Test circuit for inductive load switching



### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

	Dim	mm		
	Dim.	Min.	Тур.	Max.
	А	4.40		4.60
	A1	0.03		0.23
	b	0.70		0.93
	b2	1.14	Y	1.70
	С	0.45	10	0.60
	c2	1.23		1.36
	D	8.95	S	9.35
	D1	7.50	<sup>b</sup>	
	E	10		10.40
	E1	8.50		
	е		2.54	
	e1	4.88		5.28
opsole	ЩО	15		15.85
	J1	2.49		2.69
	KU L	2.29		2.79
	L1	1.27		1.40
	L2	1.30		1.75
	R		0.4	
	V2	0°		<b>8</b> °

Table 8. D<sup>2</sup>PAK (TO-263) mechanical data



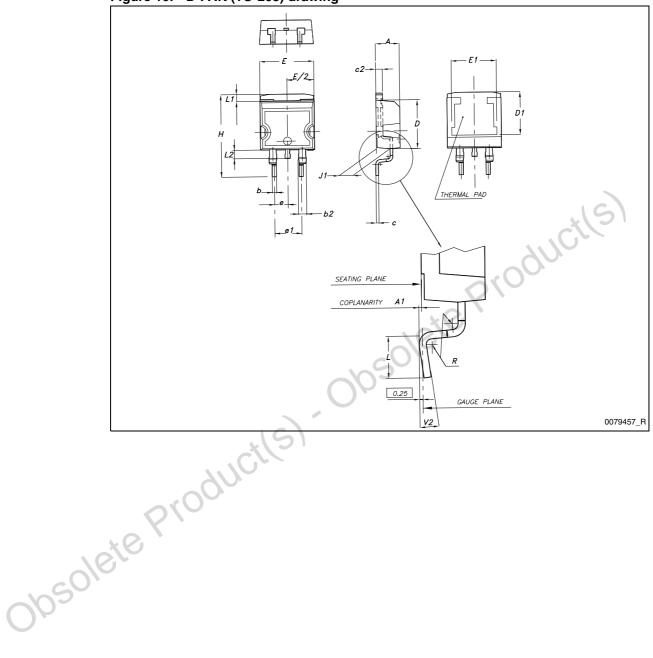


Figure 19. D<sup>2</sup>PAK (TO-263) drawing



### 5 Revision history

#### Table 9.Document revision history

	Date	Revision	Changes	
	21-Nov-2005	1	New release	
	06-Dic-2005	2	Inserted row on Table 2: Absolute maximum ratings	
	08-Feb-2007	3	Description has been updated	
	24-Feb-2011	4	Updated package mechanical data <i>Table 8. on page 8</i> and <i>Figure 19. on page 9</i>	
005018	tepro	ductl	Updated package mechanical data Table 8. on page 8 and Figure 19. on page 9	



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